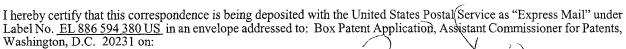
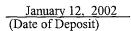
01/15/02

TRANSMITTAL FORM





Kathy Dixon

Box Patent Application Assistant Commissioner For Patents Washington, D.C. 20231

Attorney Doc. #: 67,200-557
Mailing Date: Jan. 12, 2002

Dear Sir:

Transmitted herewith for filing is the patent application of:

Inventor(s):

Chung-Shi Liu

Chen-Hua Yu

For:

Cathode Contact Pin For an Electroplating Process

Submitted herewith are:

X 2 sheets of formal drawings showing Figs 1-4C

X An Assignment of the invention to <u>Taiwan Semiconductor Manufacturing Co.</u>, <u>Ltd.</u>, together with Assignment Recordal Sheet

X A Declaration for patent application under CFR 1.63 and 1.68

The filing fee has been calculated as shown below:

	No. Filed	No. Extra	Small Entity Fee	Large Entity Fee	Total
Basic Fee			\$370.00	\$740.00	\$740.00
Total Claims	20x20	0 x	\$9.00	\$18.00	\$0
Indep. Claims	2 -3	0 x	\$42.00	\$84.00	\$0
Multiple Dep. Clms.			\$140.00	\$280.00	\$0
Assign. Rec. Fee			\$40.00	\$40.00	\$40.00
TOTAL					\$780.00

Mailing Date: 99.72, 2002Attorney Docket No.: 67,200-557

y	Attached is a Credit Card Payment Form for the sum of \$_	780.00
X	Affached is a Credit Card Payment Form for the sum of ϕ_{-}	<u> </u>

- X Charge Visa Credit Card No. 4756 8461 9568 0263 the sum of \$ 785.00 A duplicate copy of this transmittal is attached.
- The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Visa Credit Card No. <u>4756 8461 9568 0263</u>. A duplicate copy of this sheet is enclosed.
 - X Any additional filing fees required under 37 CFR 1.6 Any patent application processing fees under 37 CFR 1.17

Respectfully submitted,

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RWT/kd Enclosures